

## 4-BIT DUAL SUPPLY BUS BUFFER LEVEL TRANSLATOR WITH A SIDE SERIES RESISTOR

- HIGH SPEED:  $t_{PD} = 4.4\text{ns}$  (MAX.) at  $T_A=85^\circ\text{C}$   
 $V_{CCB} = 1.65\text{V}$ ;  $V_{CCA} = 3.0\text{V}$
- LOW POWER DISSIPATION:  
 $I_{CCA} = I_{CCB} = 5\mu\text{A}$ (MAX.) at  $T_A=85^\circ\text{C}$
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OHA}| = |I_{OLA}| = 10\text{mA}$  MIN at  
 $V_{CCA} = 3.0\text{V}$ ;  $V_{CCB} = 1.4\text{V}$  to  $3.6\text{V}$   
 $|I_{OHA}| = |I_{OLA}| = 8\text{mA}$  MIN at  
 $V_{CCA} = 2.3\text{V}$ ;  $V_{CCB} = 1.4$  to  $3.6\text{V}$ )
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \approx t_{PHL}$
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- $26\Omega$  SERIES RESISTOR ON A SIDE OUTPUTS
- OPERATING VOLTAGE RANGE:  
 $V_{CCA}(\text{OPR}) = 1.4\text{V}$  to  $3.6\text{V}$  (1.2V Data Retent)  
 $V_{CCB}(\text{OPR}) = 1.4\text{V}$  to  $3.6\text{V}$  (1.2V Data Retent)
- MAX DATA RATES:  
380 Mbps (1.8V to 3.3V translation)  
260 Mbps (<1.8V to 3.3V translation)  
260 Mbps (Translate to 2.5V)  
210 Mbps (Translate to 1.5V)  
100 Mbps (Translate to 1.2V)
- LATCH-UP PERFORMANCE EXCEEDS 500mA (JESD 17)
- ESD PERFORMANCE:  
HBM > 2000V (MIL STD 883 method 3015);  
MM > 200V
- ROHS Compliant for FLIPCHIP Package

### DESCRIPTION

The ST4G3234 is a dual supply low voltage CMOS 4-BIT BUS BUFFER level translator fabricated with sub-micron silicon gate and five-layer metal wiring C<sup>2</sup>MOS technology. Designed for use as an interface between a 3.3V bus and a 2.5V or 1.8V bus in a mixed 3.3V/1.8V, 3.3V/2.5V, 1.8V/1.4V and 2.5V/1.8V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

This IC is intended for one-way asynchronous communication between data buses. The input and output power down protections disable the device when both power supply are down, so that the buses are effectively isolated.

The input tolerant buffers allow to translate  $V_{CCB}$  compatible signals and greater signals than  $V_{CCB}$  up/down to  $V_{CCA}$ .

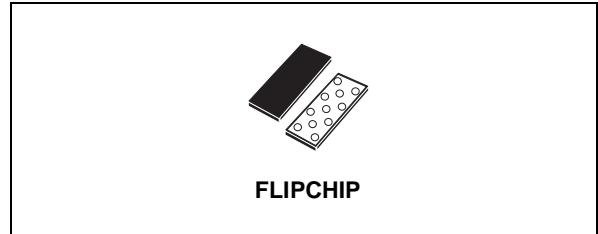
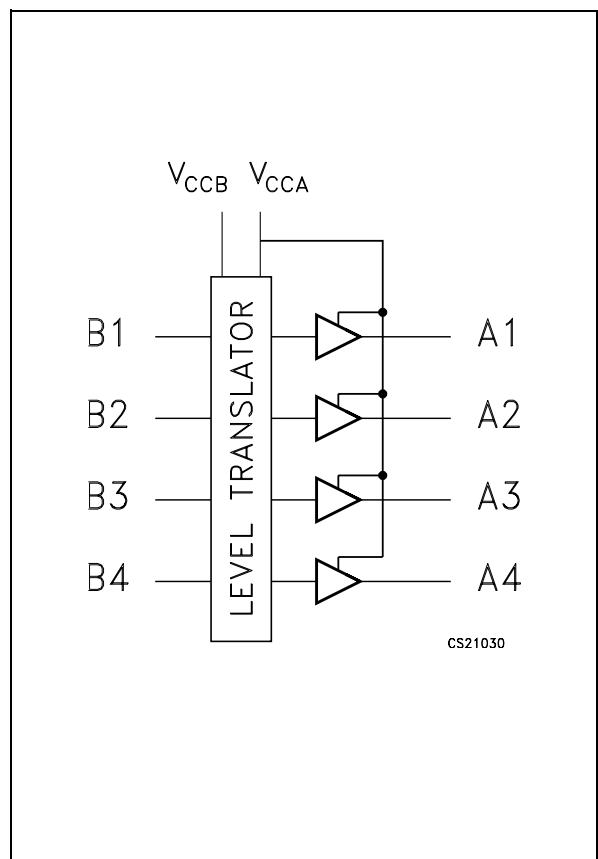


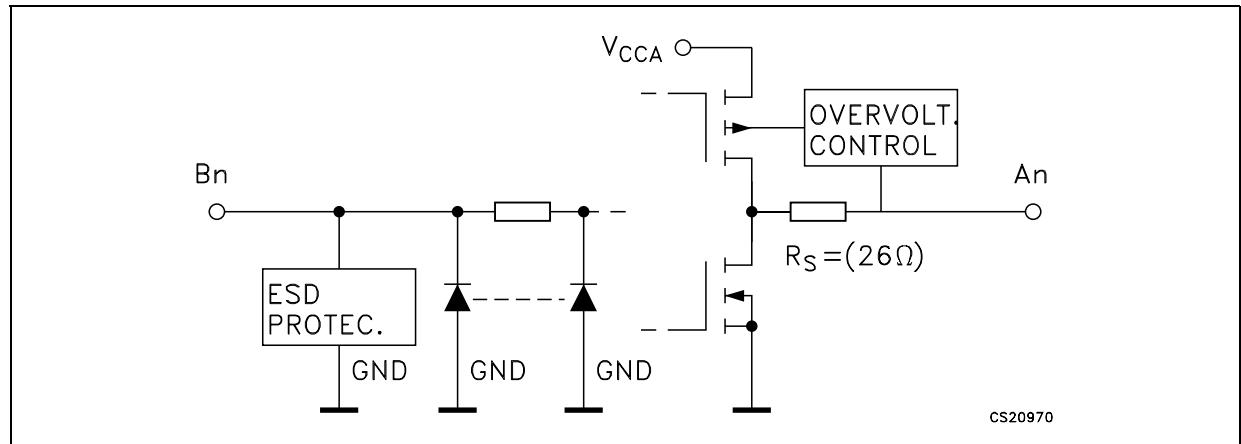
Table 1: Order Codes

PACKAGE	T & R	Comments
FLIPCHIP11	ST4G3234BJR	5000 parts per reel

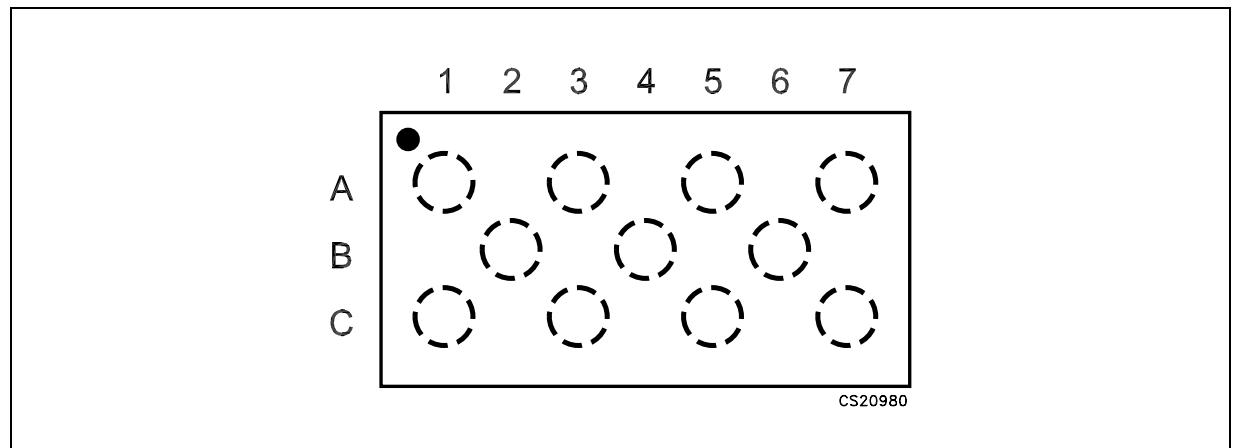
All inputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Figure 1: Logic Diagram



**Figure 2: Input And Output Equivalent Circuit****Table 2: Pin Description**

PIN°	SYMBOL	NAME AND FUNCTION
A1	A4	Data Output
A3	A3	Data Output
A5	A2	Data Output
A7	A1	Data Output
C1	B4	Data Input
C3	B3	Data Input
C5	B2	Data Input
C7	B1	Data Input
B2	GND	Ground (0V)
B6	V <sub>CCA</sub>	Positive Supply Voltage
B4	V <sub>CCB</sub>	Positive Supply Voltage

**Figure 3: Pin Connection (top through view)**

**Table 3: Truth Table**

INPUTS Bn ( $V_{CCB}$ Referred)		OUTPUTS Bn ( $V_{CCA}$ Referred)	
	L		L
	H		H

**Table 4: Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
$V_{CCA}$	Output Supply Voltage	-0.5 to +4.6	V
$V_{CCB}$	Input Supply Voltage	-0.5 to +4.6	V
$V_{OA}$	DC Output Voltage (Power Down Mode: $V_{CCA}=V_{CCB}=Gnd$ )	-0.5 to +4.6	V
$V_{IB}$	DC Input Voltage (Power Down Mode: $V_{CCA}=V_{CCB}=Gnd$ )	-0.5 to +4.6	V
$V_{OA}$	DC Output Voltage	-0.5 to $V_{CCA} + 0.5$	V
$V_{IB}$	DC Input Voltage	-0.5 to +4.6	V
$I_{IK}$	DC Input Diode Current	-20	mA
$I_{OK}$	DC Output Diode Current	-50	mA
$I_{OA}$	DC Output Current	$\pm 50$	mA
$I_{CCA}$	DC $V_{CCA}$ or Ground Current	$\pm 100$	mA
$I_{CCB}$	DC $V_{CCB}$ or Ground Current	$\pm 100$	mA
$P_d$	Power Dissipation	400	mW
$T_{stg}$	Storage Temperature	-65 to +150	°C
$T_L$	Lead Temperature (10 sec)	260	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

**Table 5: Recommended Operating Conditions**

Symbol	Parameter	Value	Unit
$V_{CCA}$	Supply Voltage	1.4 to 3.6	V
$V_{CCB}$	Supply Voltage	1.4 to 3.6	V
$V_{IB}$	Input Voltage (Bn)	0 to $V_{CCB}$	V
$V_{OA}$	Output Voltage (An)	0 to $V_{CCA}$	V
$T_{op}$	Operating Temperature	-40 to 85	°C
$dt/dv$	Input Rise and Fall Time (note 1)	$V_{CCB} = 3.0$ to 3.6V	ns/V
		$V_{CCB} = 2.3$ to 2.7V	ns/V
		$V_{CCB} = 1.4$ to 1.95V	ns/V

1)  $V_I$  from 0.8V to 2.0V at  $V_{CC} = 3.0V$

Table 6: DC Specification

Symbol	Parameter	Test Condition			Value					Unit	
		$V_{CCB}$ (V) <sup>(*)</sup>	$V_{CCA}$ (V) <sup>(*)</sup>		$T_A = 25^\circ C$			$-40 \text{ to } 85^\circ C$			
					Min.	Typ.	Max.	Min.	Max.		
$V_{IHB}$	High Level Input Voltage (Bn)	1.4	1.4 to 3.6V		0.65 $V_{CCB}$			0.65 $V_{CCB}$		V	
		1.8			0.65 $V_{CCB}$			0.65 $V_{CCB}$			
		2.5			1.6			1.6			
		3.3			2.0			2.0			
$V_{ILB}$	Low Level Input Voltage (Bn)	1.4	1.4 to 3.6V				0.35 $V_{CCB}$		0.35 $V_{CCB}$	V	
		1.8					0.35 $V_{CCB}$		0.35 $V_{CCB}$		
		2.5					0.7		0.7		
		3.3					0.8		0.8		
$V_{OHA}$	High Level Output Voltage	1.4 to 3.6V	1.4	$I_O=-100\mu A$	1.2			1.2		V	
			2.75	$I_O=-10mA$	2.2			2.2			
			2.3	$I_O=-8mA$	2.0			2.0			
			1.65	$I_O=-6mA$	1.4			1.4			
			1.4	$I_O=-2mA$	1.1			1.1			
$V_{OLA}$	Low Level Output Voltage	1.4 to 3.6V	1.4	$I_O=100\mu A$			0.2		0.2	V	
			2.75	$I_O=10mA$			0.55		0.55		
			2.3	$I_O=8mA$			0.30		0.30		
			1.65	$I_O=6mA$			0.25		0.25		
			1.4	$I_O=2mA$			0.20		0.20		
$I_{IB}$	Input Leakage Current	2.7	3.6	$V_{IB} = V_{CCB}$ or GND			$\pm 0.5$		$\pm 5$	$\mu A$	
		1.4	2.7	$V_{IB} = 3.6V$ or GND			$\pm 0.5$		$\pm 5$	$\mu A$	
$I_{OFF}$	Power Off Leakage Current	0	0	$V_{IB}=GND$ to $3.6V$ $V_{OA}=GND$ to $3.6V$			$\pm 1.0$		$\pm 10$	$\mu A$	
$I_{CCtB}$	Quiescent Supply Current	1.4 to 3.6V	1.4 to 3.6V	$V_{IB} = V_{CCB}$ or GND			0.5		5	$\mu A$	
$I_{CCtA}$	Quiescent Supply Current	1.4 to 3.6V	1.4 to 3.6V	$V_{IB} = V_{CCB}$ or GND			0.5		5	$\mu A$	
$\Delta I_{CCtB}$	Maximum Quiescent Supply Current / Input (Bn)	2.7	3.6	$V_{IB} = V_{CCB} - 0.6V$ $V_{IB} = V_{CCB}$ or GND					0.75	mA	
		1.95	3.6								
		1.95	2.7								

(\*)  $V_{CC}$  range =  $3.3 \pm 0.3$ ;  $2.5 \pm 0.2V$ ;  $1.8 \pm 0.15V$

**Table 7: Dynamic Switching Characteristics**

Symbol	Parameter	Test Condition			Value					Unit	
		V <sub>CCB</sub> (V)	V <sub>CCA</sub> (V)		T <sub>A</sub> = 25 °C		-40 to 85 °C				
					Min.	Typ.	Max.	Min.	Max.		
V <sub>OLPA</sub>	Dynamic Low Level Quiet An Output	1.4	1.8	C <sub>L</sub> =30pF V <sub>IL</sub> =0V V <sub>IH</sub> =V <sub>CC</sub>	0.2					V	
		1.4-1.8	2.5		0.25						
		1.8-2.5	3.3		0.35						
V <sub>OLVA</sub>	Dynamic Low Level Quiet An Output	1.4	1.8	C <sub>L</sub> =30pF V <sub>IL</sub> =0V V <sub>IH</sub> =V <sub>CC</sub>	-0.2					V	
		1.4-1.8	2.5		-0.25						
		1.8-2.5	3.3		-0.35						
V <sub>OHVA</sub>	Dynamic High Level Quiet An Output	1.4	1.8	C <sub>L</sub> =30pF V <sub>IL</sub> =0V V <sub>IH</sub> =V <sub>CC</sub>	1.6					V	
		1.4-1.8	2.5		2.1						
		1.8-2.5	3.3		2.7						

**Table 8: AC Electrical Characteristics**

Symbol	Parameter	Test Condition			Value		Unit	
		V <sub>CCB</sub> (V)	V <sub>CCA</sub> (V)		-40 to 85 °C			
					Min.	Max.		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time Bn to An	2.3 to 3.6	1.4	C <sub>L</sub> = 10 pF	2.0	5.5	ns	
		1.4 to 1.95	1.4		2.0	5.5		
		2.3 to 3.6	1.65 to 1.95		2.0	5.0		
		1.4 to 1.95	1.65 to 1.95		2.0	5.2		
		1.4 to 1.95	2.3 to 2.7		2.0	4.6		
		1.4 to 1.95	3.0 to 3.6		2.0	4.3		
		2.3 to 2.7	3.0 to 3.6		1.0	3.5		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time Bn to An	2.3 to 3.6	1.4	C <sub>L</sub> = 30 pF R <sub>L</sub> = 500 Ω	2.0	7.5	ns	
		1.4 to 1.95	1.4		2.0	7.9		
		2.3 to 3.6	1.65 to 1.95		2.0	6.0		
		1.4 to 1.95	1.65 to 1.95		2.0	6.5		
		1.4 to 1.95	2.3 to 2.7		2.0	5.7		
		1.4 to 1.95	3.0 to 3.6		2.0	5.2		
		2.3 to 2.7	3.0 to 3.6		1.0	4.6		
t <sub>OSLH</sub> t <sub>OSSL</sub>	Output To Output Skew Time (note1, 2)	1.8 ± 0.15	2.5 ± 0.2	C <sub>L</sub> = 30 pF R <sub>L</sub> = 500 Ω		0.5	ns	
		1.8 ± 0.15	3.3 ± 0.3			0.5		
		2.5 ± 0.2	3.3 ± 0.3			0.75		

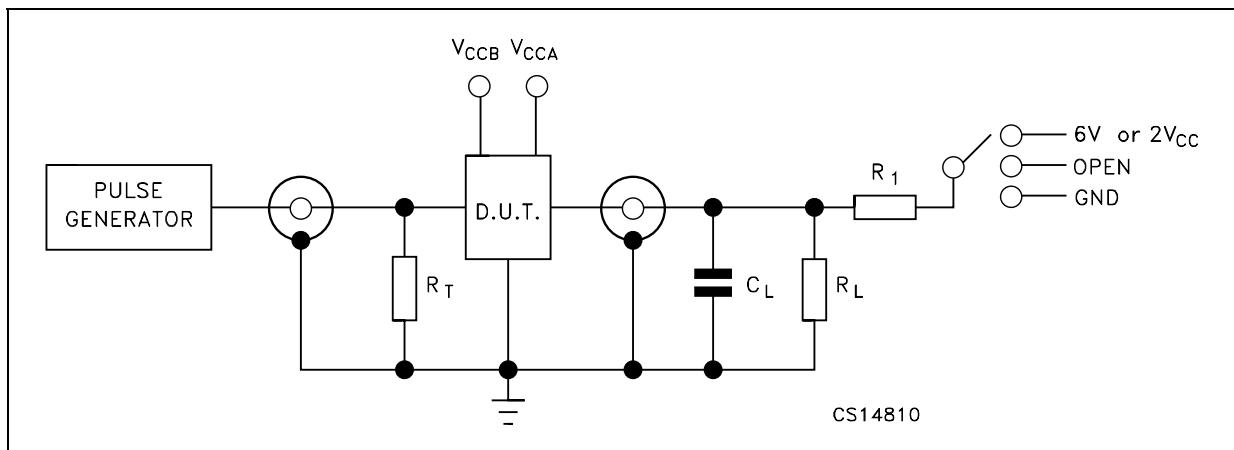
1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ( $t_{OSLH} = | t_{PLHm} - t_{PLHn} |$ ,  $t_{OSSL} = | t_{PHLm} - t_{PHLn} |$ )

2) Parameter guaranteed by design

**Table 9: Capacitance Characteristics**

Symbol	Parameter	Test Condition			Value					Unit	
		V <sub>CCB</sub> (V)	V <sub>CCA</sub> (V)		T <sub>A</sub> = 25 °C		-40 to 85 °C				
					Min.	Typ.	Max.	Min.	Max.		
C <sub>INB</sub>	Input Capacitance	open	open			7				pF	
C <sub>O</sub>	Output Capacitance	2.5	3.3			9				pF	
C <sub>PD</sub>	Power Dissipation Capacitance	2.5	3.3	f=10MHz		28				pF	
		1.8	3.3			28					
		1.4	2.5			25					
		1.4	1.8			21					
		3.3	1.8			28					

1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation. I<sub>CC(opr)</sub> = C<sub>PD</sub> × V<sub>CC</sub> × f<sub>IN</sub> + I<sub>CC</sub>/4 (per circuit)

**Figure 4: Test Circuit**

TEST	SWITCH
t <sub>PLH</sub> , t <sub>PHL</sub>	Open

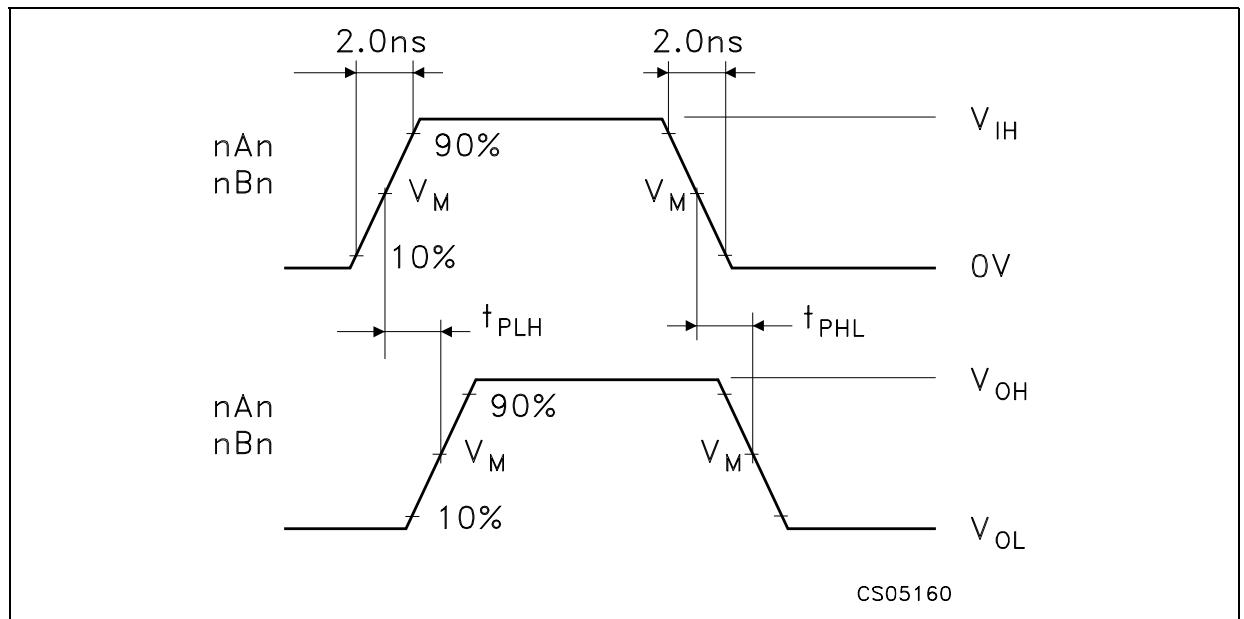
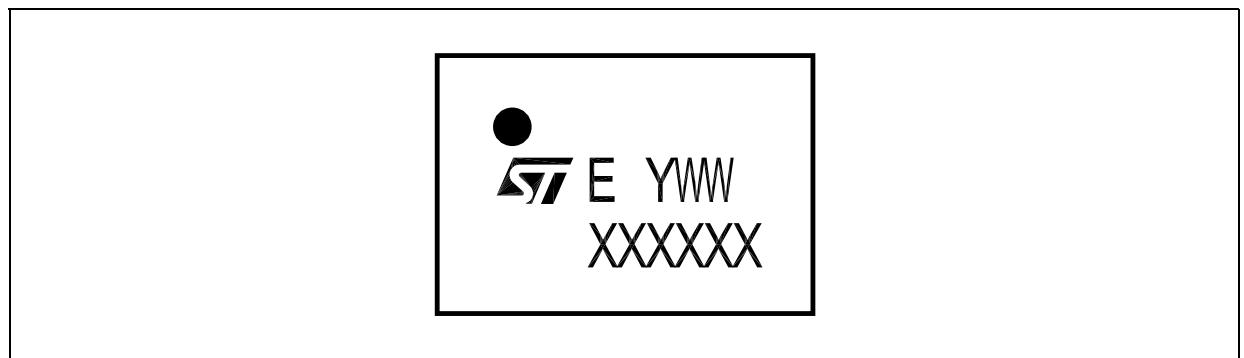
C<sub>L</sub> = 30pF or equivalent (includes jig and probe capacitance)

R<sub>L</sub> = R<sub>1</sub> = 500Ω or equivalent

R<sub>T</sub> = Z<sub>OUT</sub> of pulse generator (typically 50Ω)

**Table 10: Waveform Symbol Value**

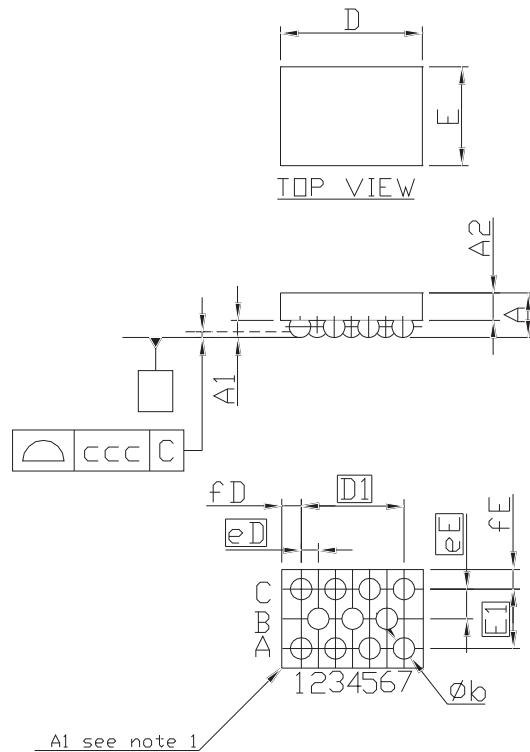
Symbol	V <sub>CC</sub>		
	3.0 to 3.6V	2.3 to 2.7V	1.65 to 1.95V
V <sub>IH</sub>	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>
V <sub>M</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>X</sub>	V <sub>OL</sub> +0.3V	V <sub>OL</sub> +0.15V	V <sub>OL</sub> +0.15V
V <sub>Y</sub>	V <sub>OL</sub> -0.3V	V <sub>OL</sub> -0.15V	V <sub>OL</sub> -0.15V

**Figure 5: Waveform - Propagation Delay (f=1MHz; 50% duty cycle)****Figure 6: Marking**

NOTE: E = Eco Level; Y = Assy Year; WW = Assy Week; X = Marking Area; Marking Code 9521

## Flip-Chip11 MECHANICAL DATA

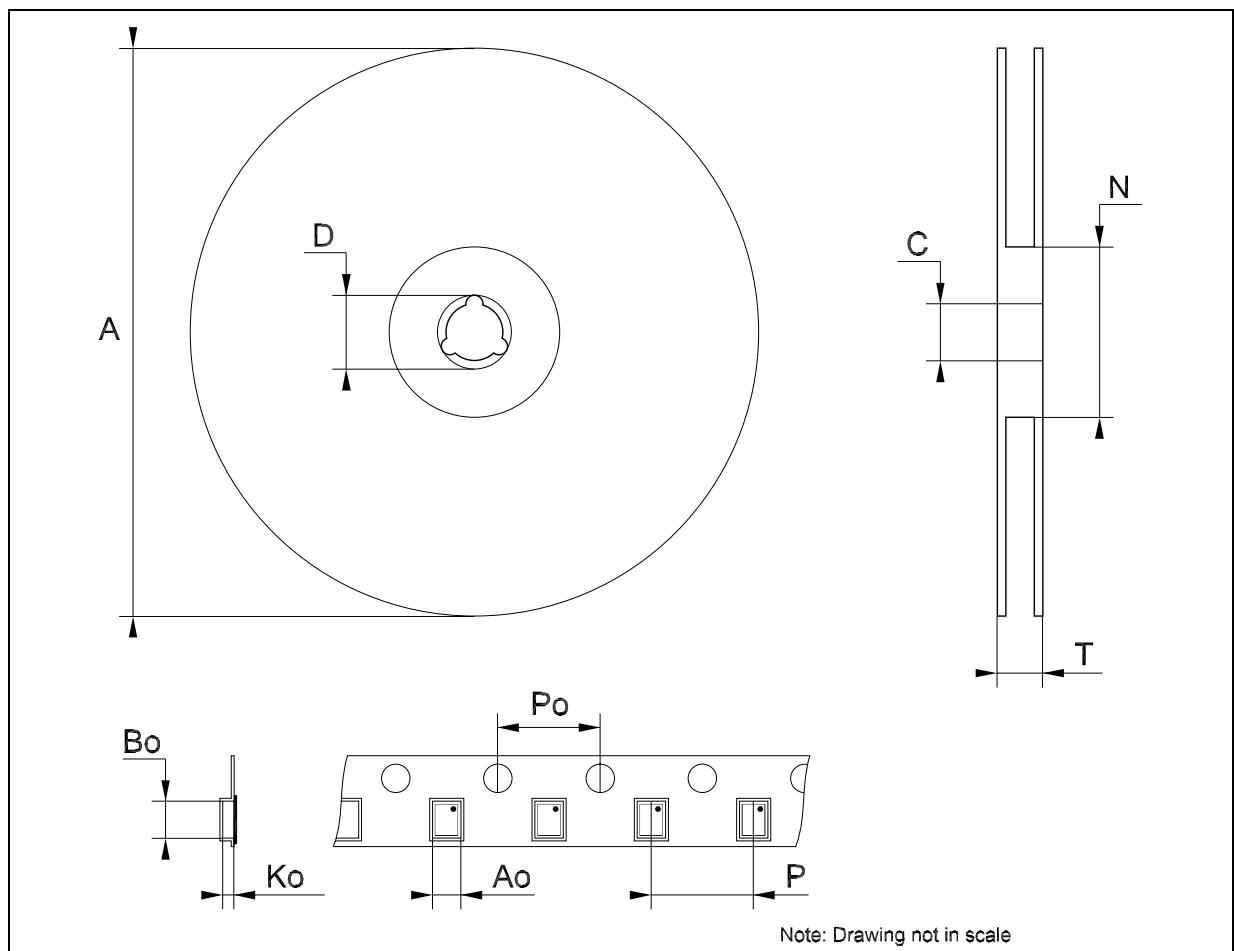
DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.585	0.65	0.715	23.0	25.6	28.1
A1	0.21	0.25	0.29	8.3	9.8	11.4
A2		0.40			15.7	
b	0.265	0.315	0.365	10.4	12.4	14.4
D	1.99	2.04	2.09	78.3	80.3	82.3
D1		1.5			59.1	
E	1.36	1.41	1.46	53.5	55.5	57.5
E1		0.866			34.1	
eD	0.2	0.25	0.30	7.9	9.8	11.8
eE	0.383	0.433	0.483	15.1	17.0	19.0
fD		0.270			10.6	
fE		0.272			10.7	
ccc		0.080			3.1	



7224724E

## Tape & Reel Flip-Chip 11 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			178			6.926
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	49	50	51	1.929	1.969	2.008
T			12.4			0.488
Ao	2.29	2.34	2.39	0.090	0.092	0.094
Bo	1.65	1.70	1.75	0.065	0.067	0.069
Ko	0.76	0.81	0.86	0.030	0.032	0.034
Po	3.9	4	4.1	0.153	0.157	0.161
P	3.9	4	4.1	0.153	0.157	0.161



Note: Drawing not in scale

**Table 11: Revision History**

Date	Revision	Description of Changes
14-Oct-2004	1	First Release.
26-Oct-2004	2	Mechanical Data has been updated.
18-Nov-2004	3	Mistake $V_{OHA}$ on table 6.
11-Feb-2005	4	Add Tape & Reel and Figure 6.
18-Feb-2005	5	Table 1 has been updated from 4000 to 5000 parts per Reel.
18-Mar-2005	6	Add Features ==> Max Data Rates.
09-May-2005	7	Table 8 and Table 9 have been updated.

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